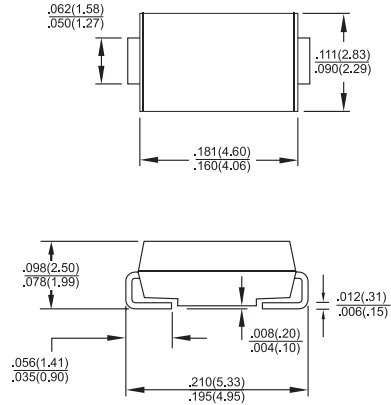


Surface Mount Schottky Rectifiers

SMA/DO-214AC

Features

- ✧ For surface mounted application
- ✧ Easy pick and place
- ✧ Metal to silicon rectifier, majority carrier conduction
- ✧ Low power loss, high efficiency
- ✧ High current capability, low VF
- ✧ High surge current capability
- ✧ Plastic material used carriers Underwriters Laboratory Classification 94V-0
- ✧ Epitaxial construction
- ✧ High temperature soldering: 260°C / 10 seconds at terminals



Mechanical Data

- ✧ Case: JEDEC DO-214AC Molded plastic
- ✧ Terminals: Pure tin plated, lead free
- ✧ Polarity: Indicated by cathode band
- ✧ Packaging: 16mm tape per EIA STD RS-481

Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	SS 32	SS 33	SS 34	SS 35	SS 36	SS 39	SS 310	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	20	30	40	50	60	90	100	V
Maximum RMS Voltage	V_{RMS}	14	21	28	35	42	63	70	V
Maximum DC Blocking Voltage	V_{DC}	20	30	40	50	60	90	100	V
Maximum Average Forward Rectified Current at T_L (See Fig. 1)	$I_{(AV)}$	3.0							A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	100				70			A
Maximum Instantaneous Forward Voltage (Note 1) IF= 3.0A @ 25°C @ 100°C	V_F	0.5 0.4		0.75 0.65		0.85 0.70		V	
Maximum DC Reverse Current @ $T_A=25^\circ\text{C}$ at Rated DC Blocking Voltage @ $T_A=125^\circ\text{C}$	I_R	0.5				0.1		mA	
		10		5		0.5		mA	
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$ $R_{\theta JA}$	17 55					°C/W		
Operating Temperature Range	T_J	-55 to +125			-55 to +150			°C	
Storage Temperature Range	T_{STG}	-55 to +150							°C

Notes: 1. Pulse Test with PW=300 usec, 1% Duty Cycle

FIG.1- MAXIMUM FORWARD CURRENT DERATING CURVE

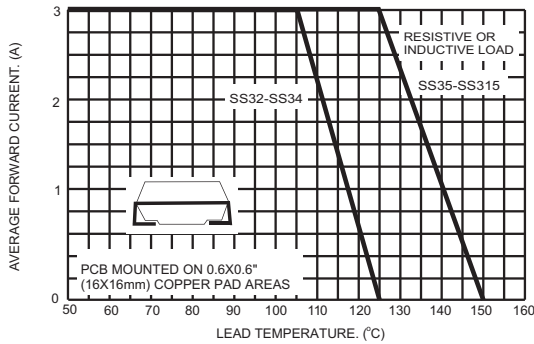


FIG.2- MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

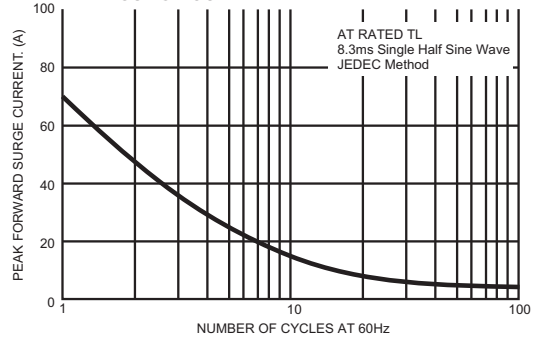


FIG.3- TYPICAL FORWARD CHARACTERISTICS

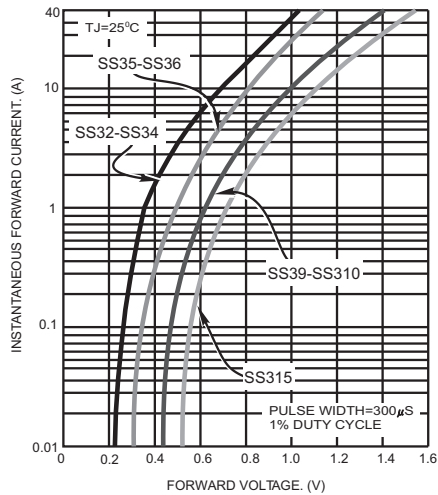


FIG.4- TYPICAL REVERSE CHARACTERISTICS

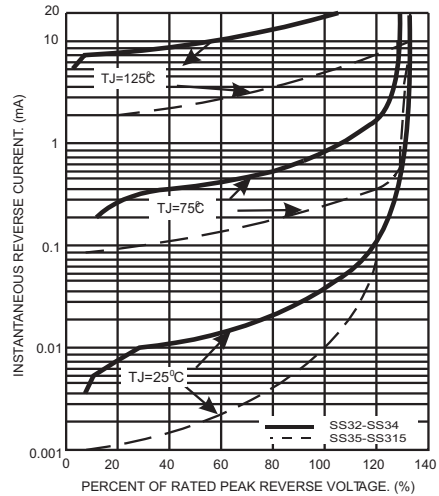


FIG.5- TYPICAL JUNCTION CAPACITANCE

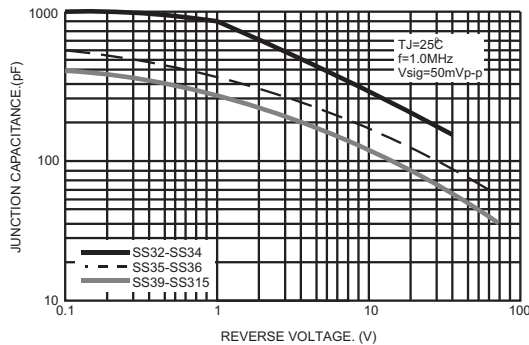
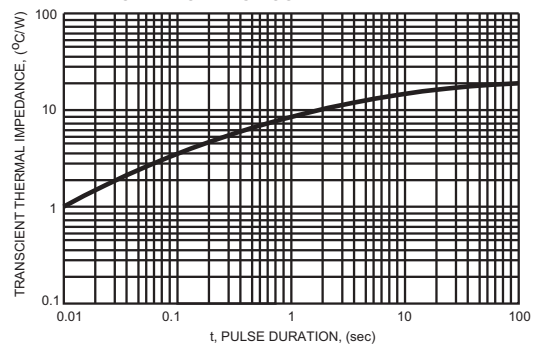


FIG.6- TYPICAL TRANSIENT THERMAL CHARACTERISTICS



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